



Specification for Approval

SAMPLES
ATTACHED AREA

- DEVICE NUMBER: BPI-3C2-02
- CUSTOMER:

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2015/1/26	1.0	1.0	1.0	1.0	1.0	1.0					Initial Released

FOR CUSTOMER'S APPROVAL STAMP OR SIGNATURE

APPROVED	PURCHASE	MANUFACTURE	QUALITY	ENGINEERING

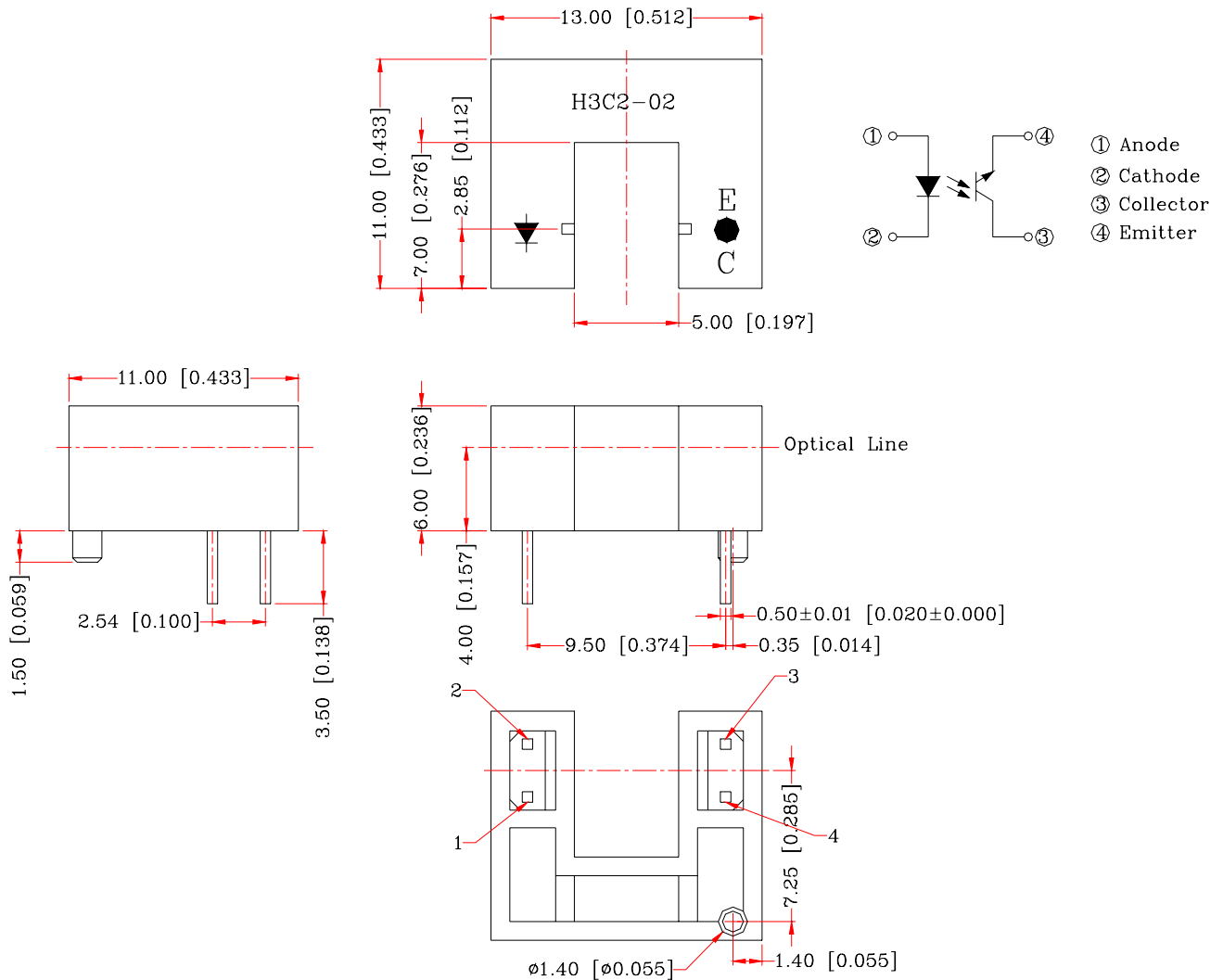
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ISSUED	APPROVED	PREPARED
	張孝嚴	莫銳明

● Features:

- * Non-contact switching.
- * For direct pc board or dual-in-line socket mounting.
- * Fast switching speed.
- * This product doesn't contain restriction substance, comply RoHS standard.

● Package Dimensions



Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is ± 0.25 mm unless otherwise specified.
3. Lead spacing is measured where the leads emerge from the package.
4. Specifications are subject to change without notice.



● Absolute Maximum Rating (Ta=25°C)

Item		Symbol	Rating	Unit
Input	Power Dissipation	Pd	75	mW
	Reverse Voltage	V _R	5	V
	Forward Current	I _F	50	mA
	Peak Forward Current (*1)	I _{FP}	1	A
Output	Collector Power Dissipation	P _C	100	mW
	Collector Current	I _C	20	mA
	C-E Voltage	V _{CEO}	30	V
	E-C Voltage	V _{ECO}	5	V
Operating Temperature		Topr	-40 ~ +85	°C
Storage Temperature		Tstg	-45 ~ +85	°C
Soldering Temperature (*2)		Tsol	260	°C

(*1) tw=100 uSec. 、 T=10 mSec.

(*2) t=5 Sec

● Electrical Optical Characteristics (Ta=25°C)

Parameter		Symbol	Condition	Min.	Typ.	Max.	Unit	Bin No.
Input	Forward Voltage	V _F	I _F =20mA	—	1.2	1.5	V	
	Reverse Current	I _R	V _R =5V	—	—	100	μA	
	Peak Wavelength	λ _p	I _F =10mA		940		nm	
Output	Dark Current	I _D	V _{CE} =5V	—	—	0.5	uA	
	C-E Saturation Voltage	V _{CE(sat)}	I _C =0.25mA I _F =10mA	—	—	0.4	V	
Light Current		I _L	V _{CE} =5V I _F =10mA	0.5	—	5	mA	
Speed	Rise Time	Tr	I _{FP} =20mA V _{CE} =5V	—	20	—	μsec	
	Fall Time	Tf	R _L =1000Ω	—	20	—		

● Typical Electrical / Optical Characteristics Curves (Ta=2°C)

Fig.1 Power Dissipation vs. Ambient Temperature

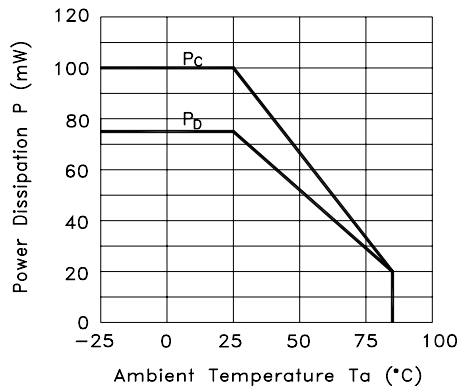


Fig.2 Forward Current vs. Forward Voltage

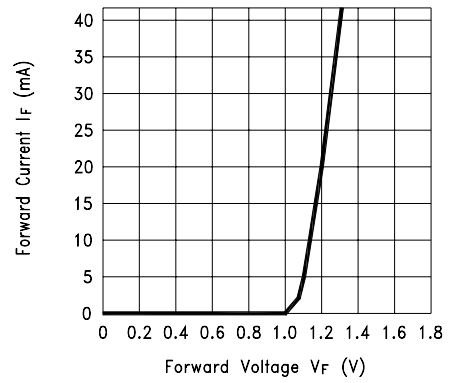


Fig.3 Collector Current vs. Collector-emitter Voltage

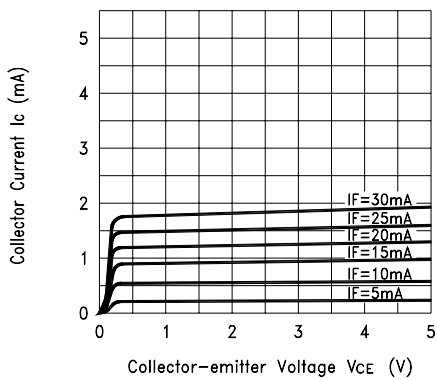
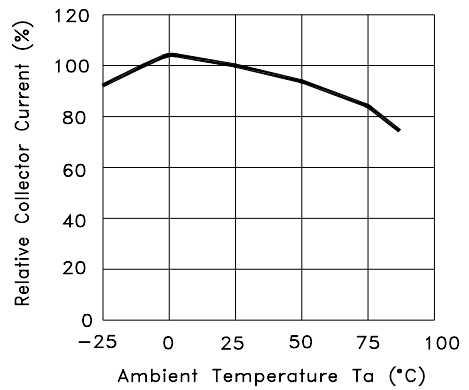


Fig.4 Collector Current vs. Ambient Temperature



● Typical Electrical / Optical Characteristics Curves (Ta=25°C)

Fig.5 Collector-emitter Saturation Voltage vs. Ambient Temperature

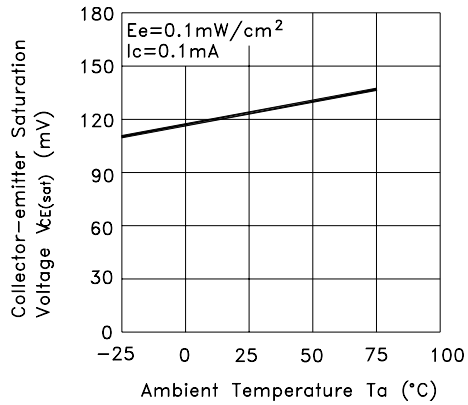


Fig.6 Response Time vs. Load Resistance

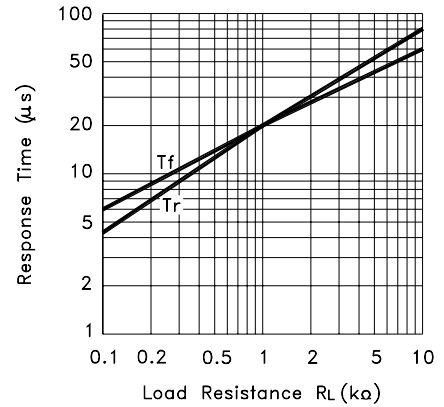
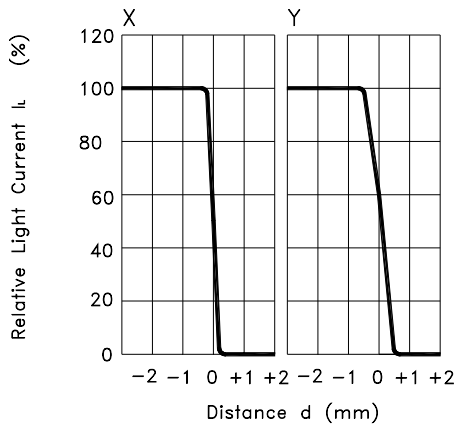
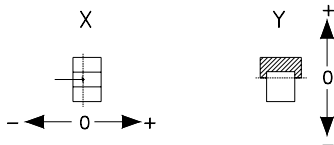


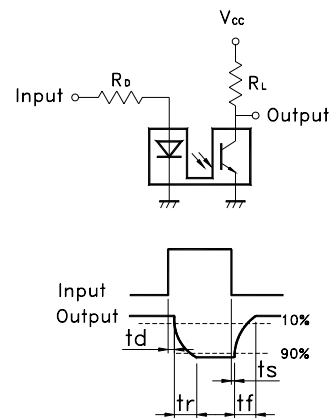
Fig.7 Sensing Position Characteristics (Typical)



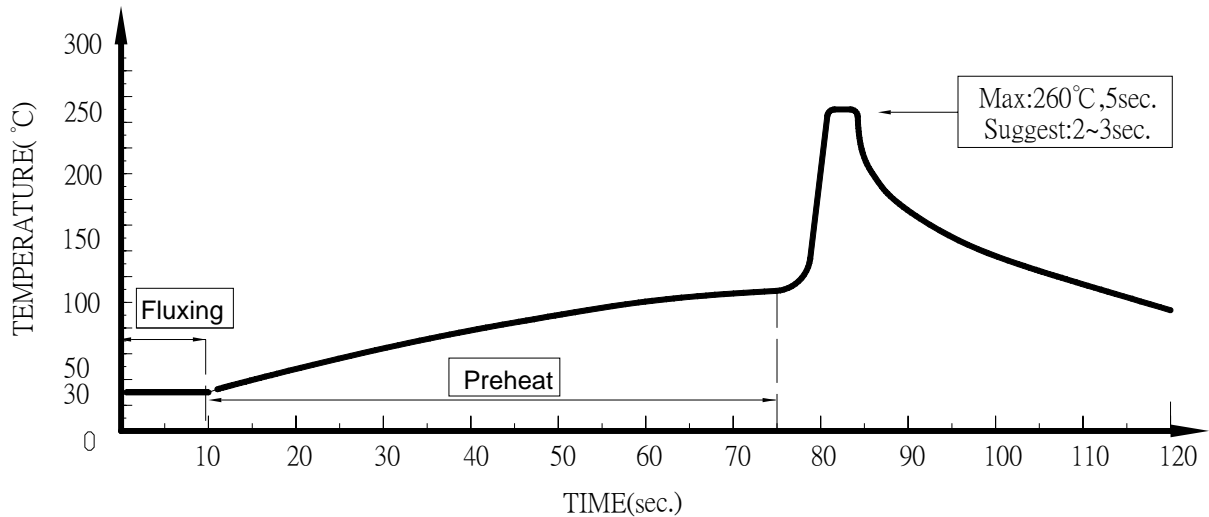
(Center of Optical axis)



Test Circuit for Response Time



● Dip Soldering



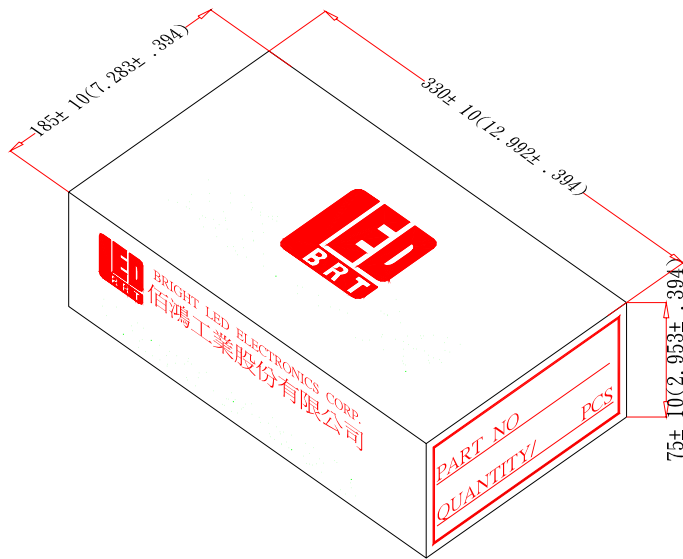
1. Please avoid any external stress applied to the lead-frames and epoxy while the LEDs are at high temperature, especially during soldering
2. DIP soldering and hand soldering should not be done more than one time.
3. After soldering, avoid the epoxy lens from mechanical shock or vibration until the LEDs are back to room temperature.
4. Avoid rapid cooling during temperature ramp-down process
5. Although the soldering condition is recommended above, soldering at the lowest possible temperature is feasible for the LEDs

● IRON Soldering

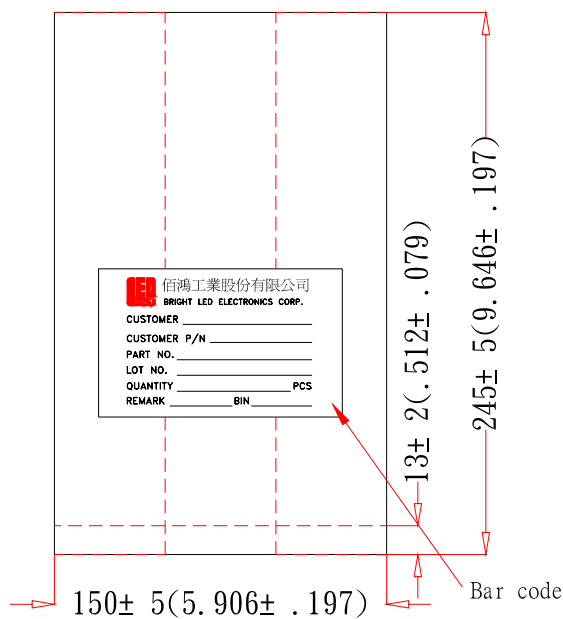
300°C Within 3 sec., One time only.



● Packaging Box Dimensions



● Packaging Bag Dimensions



Notes:

1. 500pcs per bag, 2000pcs per box..
2. All Dimensions are in millimeters (inches).
3. Specifications are subject to change without notice.